

STS4DNF60

N-channel 60V - 0.070Ω - 4A - SO-8 STripFET™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS4DNF60	60V	<0.090Ω	4A

- Standard outline for easy automated surface mount assembly
- Low threshold drive

Description

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.



■ Switching applications

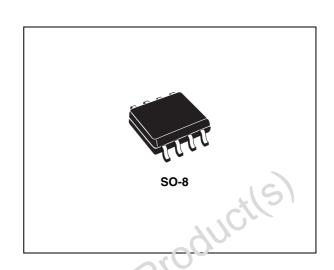


Figure 1. Internal schematic diagram

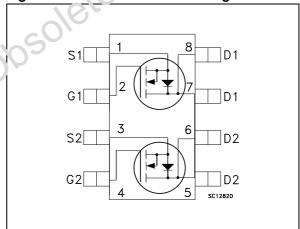


Table Device summary

Order code	Order code Marking		Packaging	
STS4DNF60	4DF60	SO-8	Tape & reel	

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0050	Revision history

STS4DNF60 **Electrical ratings**

Electrical ratings 1

Table 2. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	60	V
V _{GS}	Gate- source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25°C	4	Α
I _D	Drain current (continuous) at T _C = 100°C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	16	Α
P _{TOT} ⁽²⁾	Total dissipation at T _C = 25°C	2	W
T _j T _{stg}	Operating junction temperature Storage temperature -55 to 150		°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

T _{stg}	Storage temperature				
Pulse width limited by safe operating area					
2. P _{TOT} =1.6W for single operation					
	4110				
Table 3.	Table 3. Thermal data				
Symbol	Parameter	Value	Unit		
Rthj-pcb	Thermal resistance junction-pcb D.O. ⁽¹⁾	62.5	°C/W		

obsolete Product(s) 1. When mounted on inch² FR-4 board, 2 Oz Cu, $t \le 10$ sec, dual operation

^{2.} P_{TOT}=1.6W for single operation

Electrical characteristics STS4DNF60

2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250\mu A, V_{GS} = 0$	60			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T_{C} =125°C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10V, I_D = 2A$		0.070	0.090	Ω

Table 5. Dynamic

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)}	Turn-on delay time Rise time	$V_{DD} = 30V$, $I_D = 2A$, $R_G = 4.7\Omega$, $V_{GS} = 10V$ (see Figure 12)		7 18		ns ns
t _{d(off)}	Turn-off delay time Fall time	$V_{DD} = 30V$, $I_D = 2A$, $R_G = 4.7\Omega$, $V_{GS} = 10V$ (see Figure 12)		17 6		ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				4 16	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 4A, V _{GS} = 0		Α.	1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 4A, di/dt = 100A/ μ s V_{DD} = 20V, T_j = 25°C (see <i>Figure 17</i>)	79	45 68 3		ns nC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 4A, di/dt = 100A/µs V_{DD} = 20V, T_j = 150°C (see <i>Figure 17</i>))	50 88 3.5		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

Electrical characteristics STS4DNF60

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

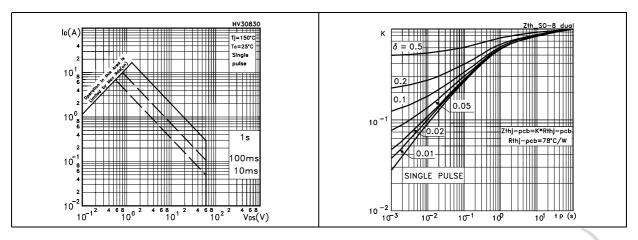


Figure 4. Output characteristics

Figure 5. Transfer characteristics

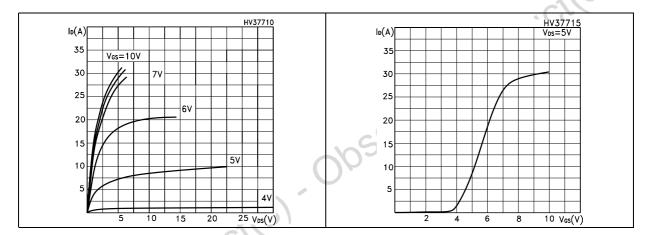


Figure 6. Source-drain diode forward characteristics

Figure 7. Static drain-source on resistance

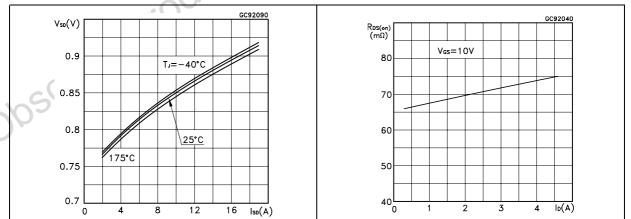


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

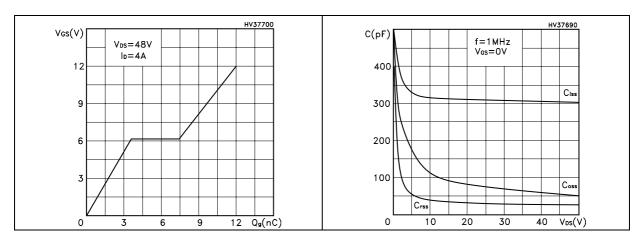
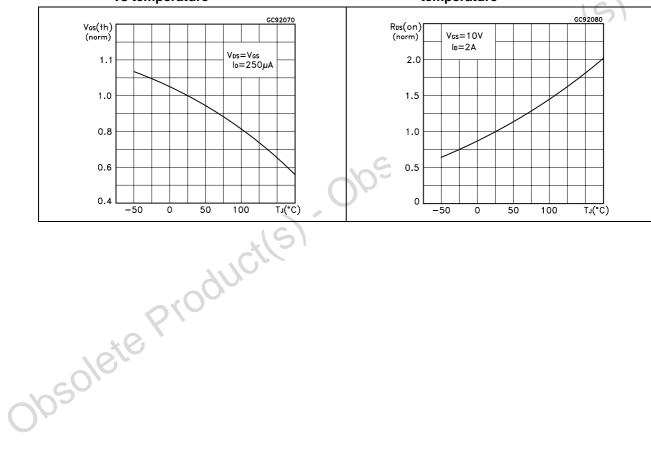


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature



Test circuits STS4DNF60

3 Test circuits

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

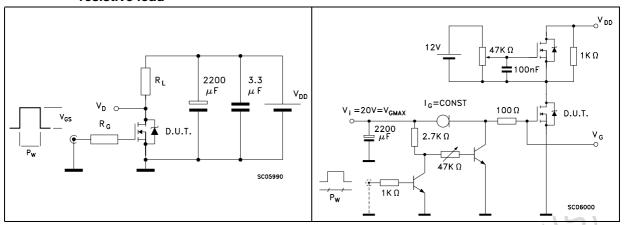


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

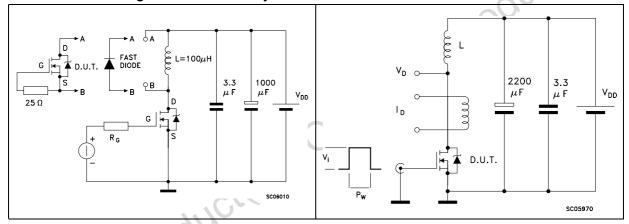
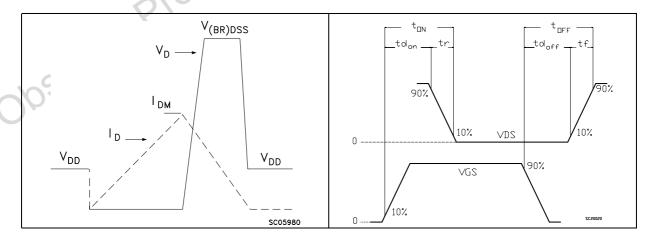


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



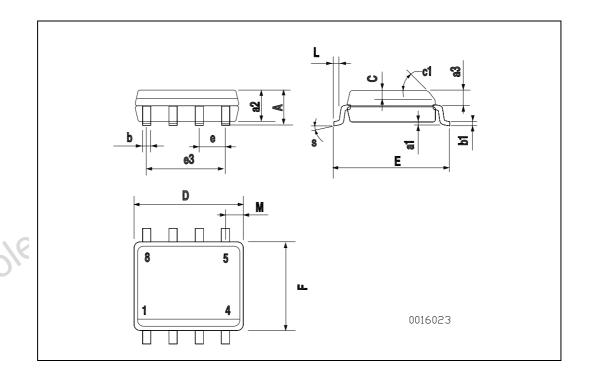
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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SO-8 MECHANICAL DATA

DIM.	mm.			inch			
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			1.75			0.068	
a1	0.1		0.25	0.003		0.009	
a2			1.65			0.064	
аЗ	0.65		0.85	0.025		0.033	
b	0.35		0.48	0.013		0.018	
b1	0.19		0.25	0.007		0.010	
С	0.25		0.5	0.010		0.019	
c1			45	(typ.)			
D	4.8		5.0	0.188		0.196	
Е	5.8		6.2	0.228		0.244	
е		1.27			0.050		
e3		3.81			0.150		
F	3.8		4.0	0.14		0.157	
L	0.4		1.27	0.015		0.050	
М			0.6			0.023	
S		•	8 (r	nax.)	•	•	



STS4DNF60 Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes	
17-May-2007	1	First release	
02-Aug-2007	2	Marking has been updated	

Obsolete Product(s). Obsolete Product(s)

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